

TOSHIBA FIELD EFFECT TRANSISTOR SILICON N CHANNEL MOS TYPE (π -MOSV)

2SK2744

HIGH SPEED, HIGH CURRENT SWITCHING APPLICATIONS

CHOPPER REGULATOR, DC-DC CONVERTER AND MOTOR DRIVE APPLICATIONS

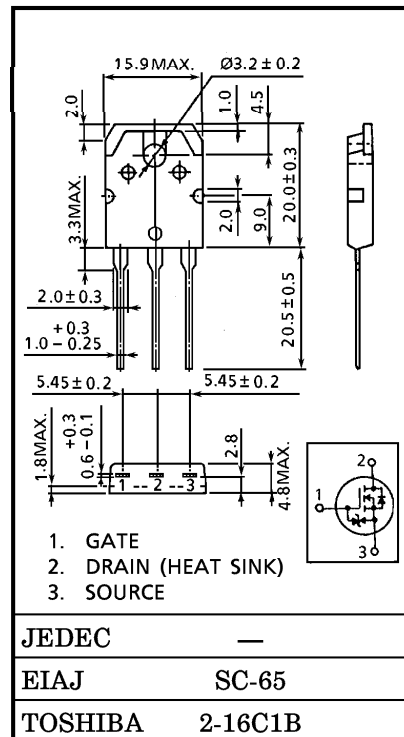
INDUSTRIAL APPLICATIONS

Unit in mm

- 4V Gate Drive
- Low Drain-Source ON Resistance : $R_{DS(ON)} = 24m\Omega$ (Typ.)
- High Forward Transfer Admittance : $|Y_{fs}| = 27S$ (Typ.)
- Low Leakage Current : $I_{DSS} = 100\mu A$ (Max.) ($V_{DS} = 50V$)
- Enhancement-Mode : $V_{th} = 1.5 \sim 3.5V$ ($V_{DS} = 10V, I_D = 1mA$)

MAXIMUM RATINGS ($T_a = 25^\circ C$)

CHARACTERISTIC		SYMBOL	RATING	UNIT
Drain-Source Voltage		V_{DSS}	50	V
Drain-Gate Voltage ($R_{GS} = 20k\Omega$)		V_{DGR}	50	V
Gate-Source Voltage		V_{GSS}	± 20	V
Drain Current	DC	I_D	45	A
	Pulse	I_{DP}	180	A
Drain Power Dissipation ($T_c = 25^\circ C$)		P_D	125	W
Single Pulse Avalanche Energy**		E_{AS}	95	mJ
Avalanche Current		I_{AR}	45	A
Repetitive Avalanche Energy*		E_{AR}	12.5	mJ
Channel Temperature		T_{ch}	150	$^\circ C$
Storage Temperature Range		T_{stg}	$-55 \sim 150$	$^\circ C$



Weight : 4.6g (Typ.)

THERMAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	MAX.	UNIT
Thermal Resistance, Channel to Case	$R_{th(ch-c)}$	1.0	$^\circ C / W$
Thermal Resistance, Channel to Ambient	$R_{th(ch-a)}$	50	$^\circ C / W$

Note ;

* Repetitive rating ; Pulse Width Limited by Max. junction temperature.

** $V_{DD} = 25V$, Starting $T_{ch} = 25^\circ C$, $L = 58\mu H$, $R_G = 25\Omega$, $I_{AR} = 45A$

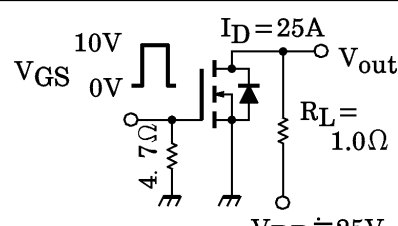
This transistor is an electrostatic sensitive device.

Please handle with caution.

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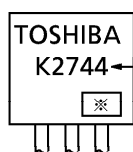
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage Current		IGSS	VGS = ±16V, VDS = 0V	—	—	±10	μA
Drain Cut-off Current		IDSS	VDS = 50V, VGS = 0V	—	—	100	μA
Drain-Source Breakdown Voltage		V(BR)DSS	ID = 10mA, VGS = 0V	50	—	—	V
Gate Threshold Voltage		Vth	VDS = 10V, ID = 1mA	1.5	—	3.5	V
Drain-Source ON Resistance		RDS(ON)	VGS = 10V, ID = 25A	—	15	20	mΩ
Forward Transfer Admittance		Yfs	VDS = 10V, ID = 25A	15	27	—	S
Input Capacitance		Ciss	VDS = 10V, VGS = 0V, f = 1MHz	—	2300	—	pF
Reverse Transfer Capacitance		Crss		—	420	—	
Output Capacitance		Coss		—	1200	—	
Switching Time	Rise Time	tr	 <p>VGS = 10V, 0V ID = 25A VDD = 25V RL = 1.0Ω</p>	—	30	—	ns
	Turn-on Time	ton		—	45	—	
	Fall Time	tf		—	80	—	
	Turn-off Time	toff		VIN : tr, tf < 5ns, Duty ≤ 1%, tw = 10μs	—	230	
Total Gate Charge (Gate-Source Plus Gate-Drain)		Qg	VDD = 40V, VGS = 10V, ID = 45A	—	68	—	nC
Gate-Source Charge		Qgs		—	20	—	
Gate-Drain ("Miller") Charge		Qgd		—	48	—	

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Drain Reverse Current	IDR	—	—	—	45	A
Pulse Drain Reverse Current	IDRP	—	—	—	180	A
Diode Forward Voltage	VDSF	IDR = 45A, VGS = 0V	—	—	-1.8	V
Reverse Recovery Time	trr	IDR = 45A, VGS = 0V	—	130	—	ns
Reverse Recovery Charge	Qrr	dIDR / dt = 50A / μs	—	0.3	—	nC

MARKING



TYPE

※ Lot Number

□ □ — Month (Starting from Alphabet A)

— Year (Last Number of the Christian Era)